

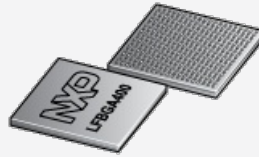


arch...



# MCIMX250CJM4A (Active)

i.MX25 32-bit MPU, ARM926EJ-S core, 400MHz, MAPBGA 400



Package: [LFBGA400](#)

LFBGA400; plastic, low profile fine-pitch ball grid array, 400 bumps; 0.8 mm pitch; 17 mm x 17 mm x 1.44 mm body

[Buy Options](#) | [Environmental Information](#) | [Quality Information](#) | [Shipping Information](#)

## Buy Options

**MCIMX250CJM4A** Active TRAY-Tray, Bakeable, Multiple in Drypack Distributor  
 935324402557      Min. Package Quantity: 90  
 Lead Time: 15 weeks

## Environmental Information

Material Declaration	PbFree	EU RoHS	Halogen Free	RHF Indicator	2nd Level Interconnect	REACH SVHC	Weight (mg)
<a href="#">MCIMX250CJM4A</a> (935324402557)	Yes	Yes <a href="#">Certificate Of Analysis (CoA)</a>	Yes	D	e1	<a href="#">REACH SVHC</a>	838.7

## Quality Information

Material Declaration	Safe Assure Functional Safety	Moisture Sensitivity Level (MSL)	Peak Package Body Temperature (PPT) (C°)	Maximum Tin
		Lead Free Soldering	Lead Free Soldering	Le
<a href="#">MCIMX250CJM4A</a> (935324402557)	No	3	260	

## Shipping Information

Part Number	Harmonized Tariff (US) <a href="#">Disclaimer</a>	Export Control Classification Number (US)
<a href="#">MCIMX250CJM4A</a> (935324402557)	854231	5A992

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